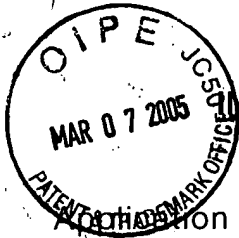


03-08-05

IFW #1



EV371300960

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. 10/734,072
Confirmation No. 8908
Filing Date December 10, 2003
Inventor Mark E. Tuttle et al.
Assignee Micron Technology, Inc.
Group Art Unit 2825
Examiner Caridad Everhart
Customer No. 021567
Attorney Docket No. MI40-369
Title: Methods for Forming Integrated Circuits Within Substrates

RESPONSE TO JANUARY 5, 2005 OFFICE ACTION

To: Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

From: Deepak Malhotra (Tel. 509-624-4276; Fax 509-838-3424)
Wells St. John P.S.
601 W. First Avenue, Suite 1300
Spokane, WA 99201-3828

AMENDMENTS

Responsive to the Office Action dated January 5, 2005, Applicants amend and remark as follows. [unless otherwise indicated, deletions are bracketed, additions are underlined]: